

MODEL NAME : **EDW40**

PCB NO : **LA-H451P**

BOM P/N : **451AFX31L01 (DIS I3 4G)**
451AFX31L02 (DIS I3 8G)
451AFX31L03 (DIS I3 16G)
451AFX31L04 (DIS I5 4G)
451AFX31L05 (DIS I5 8G)
451AFX31L06 (DIS I5 16G)
451AFX31L07 (DIS I7 4G)
451AFX31L08 (DIS I7 8G)
451AFX31L09 (DIS I7 16G)
451AFX31L10 (UMA I3 4G)
451AFX31L11 (UMA I3 8G)
451AFX31L12 (UMA I3 16G)
451AFX31L13 (UMA I5 4G)
451AFX31L14 (UMA I5 8G)
451AFX31L15 (UMA I5 16G)
451AFX31L16 (UMA I7 4G)
451AFX31L17 (UMA I7 8G)
451AFX31L18 (UMA I7 16G)
451AFX31L19 (DIS I7 16G QS)

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Schematic Document

(Omega Prime Comet Lake U)

Pilot

2019-07-15A

Rev: 1.0 (A00)

BOM Structure

PCB@ : PCB PN

UMA@ : No GPU SKU

DIS@ : GPU SKU

PRE_EVT@/EVT@/DVT1@/DVT2@/PILOT@ : Board ID

2G_G5@/N17H2G@/N17M2G@ : VRAM type

RTD3@ : TBT RTD3 Component

G3@ : EC G3 Sharing Mode

MAF@ : Master Attached Flash Sharing Mode

WWAN@ : WWAN Component

JEFF@ : Intel WLAN Jefferson Peak

TS@ : Touch Screen Component

FFS@ : Free Fall Sensor

XDP@ : XDP Component

DEBUG@ : Debug Component

CONN@ : Connector Component

@ : Un-pop Component

@RTD3@ : TBT RTD3 Un-POP Component

@WWAN@ : WWAN Un-POP Component

EMI@/ESD@/RF@ : EMI, ESD and RF Component

WWAN@RF@/WWAN@EMI@/WWAN@ESD@ : RF, EMI and ESD Component for WWAN

DISRF@ : RF Component for GPU

TS@RF@ : RF Component for Touch Screen

@EMI@/@ESD@/@RF@ : EMI, ESD and RF Un-POP Component

@WWAN@RF@/@WWAN@EMI@ : RF and EMI Un-POP Component for WWAN

S4G@/S8G@/S16G@/M4G@/M8G@/M16G@/S4G@/S8G@/S16G@ : LPDDR3 type

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Security Classification	Compal Secret Data		Title
Issued Date	2018/08/31	Deciphered Date	2018/08/06
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Date: Monday, July 15, 2019			Rev 1.0
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